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Attorneys for Plaintiffs
 HUAWEI TECHNOLOGIES CO., LTD.
 HUAWEI DEVICE USA, INC.,
 HUAWEI TECHNOLOGIES USA, INC., and
 HISILICON TECHNOLOGIES CO., LTD.

UNITED STATES DISTRICT COURT
NORTHERN DISTRICT OF CALIFORNIA

HUAWEI TECHNOLOGIES CO., LTD.,
 HUAWEI DEVICE USA, INC., and
 HUAWEI TECHNOLOGIES USA, INC.,

Plaintiffs / Counterclaim-
 Defendants,

v.

SAMSUNG ELECTRONICS CO., LTD.,
 SAMSUNG ELECTRONICS AMERICA,
 INC.,

Defendants / Counterclaim-
 Plaintiffs,

and

SAMSUNG RESEARCH AMERICA,

Defendant,

v.

HISILICON TECHNOLOGIES CO., LTD.,

Counterclaim-Defendant.

Case No. 3:16-cv-02787-WHO

NOTICE OF APPEARANCE

DEMAND FOR JURY TRIAL

1 PLEASE TAKE NOTICE that the following attorney from Sidley Austin LLP hereby files
2 this Notice of Appearance in the above-captioned case on behalf of Plaintiffs Huawei Technologies
3 Co., Ltd., Huawei Device USA, Inc., Huawei Technologies USA, Inc. and Counterclaim-Defendant
4 HiSilicon Technologies Co., Ltd. All pleadings, motions, discovery, and other material should be
5 served upon counsel at the following address:

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13 Dated: February 2, 2018

SIDLEY AUSTIN LLP

14 By: /s/ Kevin J. O'Brien
15 Kevin J. O'Brien

16 *Attorneys for Huawei Technologies Co., Ltd.,*
17 *Huawei Device USA, Inc., Huawei*
18 *Technologies USA, Inc., and HiSilicon*
19 *Technologies Co., Ltd.*